

11/18

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16

19

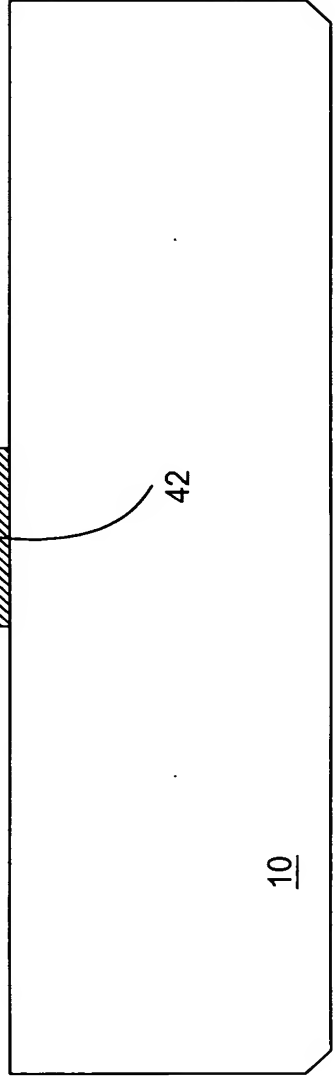
40

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42

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FIG. 1





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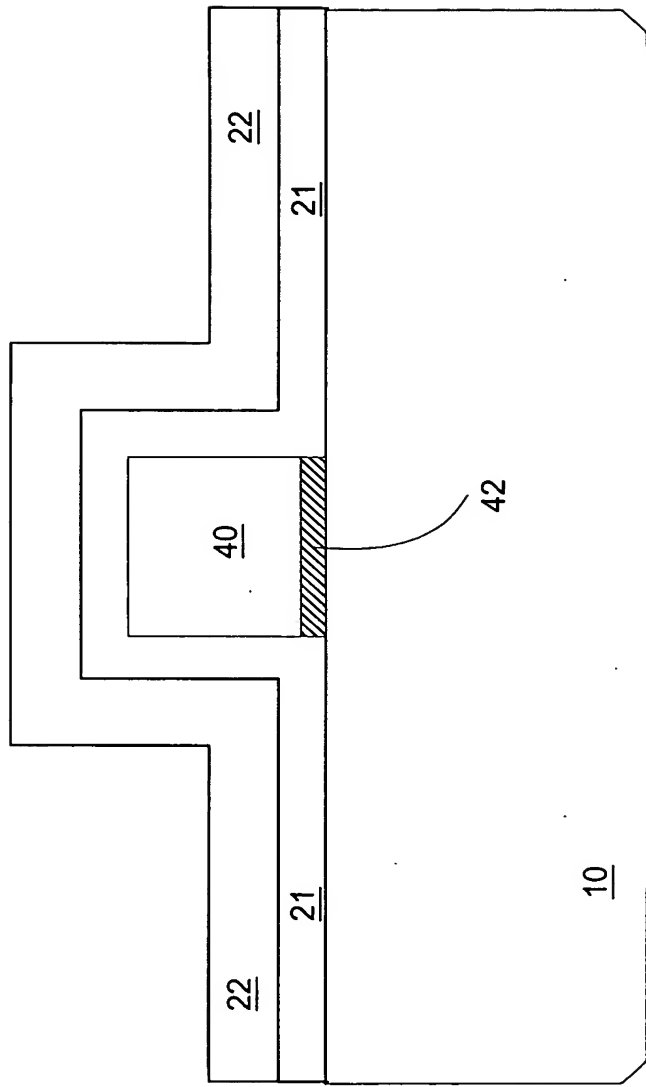


FIG. 3

FIG. 4 is a cross-sectional view of a device 10, showing a substrate 10, a layer 21, a layer 22, a layer 24, a layer 40, and a layer 42. The device 10 includes a central region 40 and side regions 24, 22, and 21. The layer 42 is a thin layer on top of the layer 40. The layer 21 is a thin layer on top of the layer 22. The layer 22 is a thin layer on top of the layer 24. The layer 24 is a thin layer on top of the substrate 10. The layer 40 is a thin layer on top of the layer 21. The layer 42 is a thin layer on top of the layer 40.

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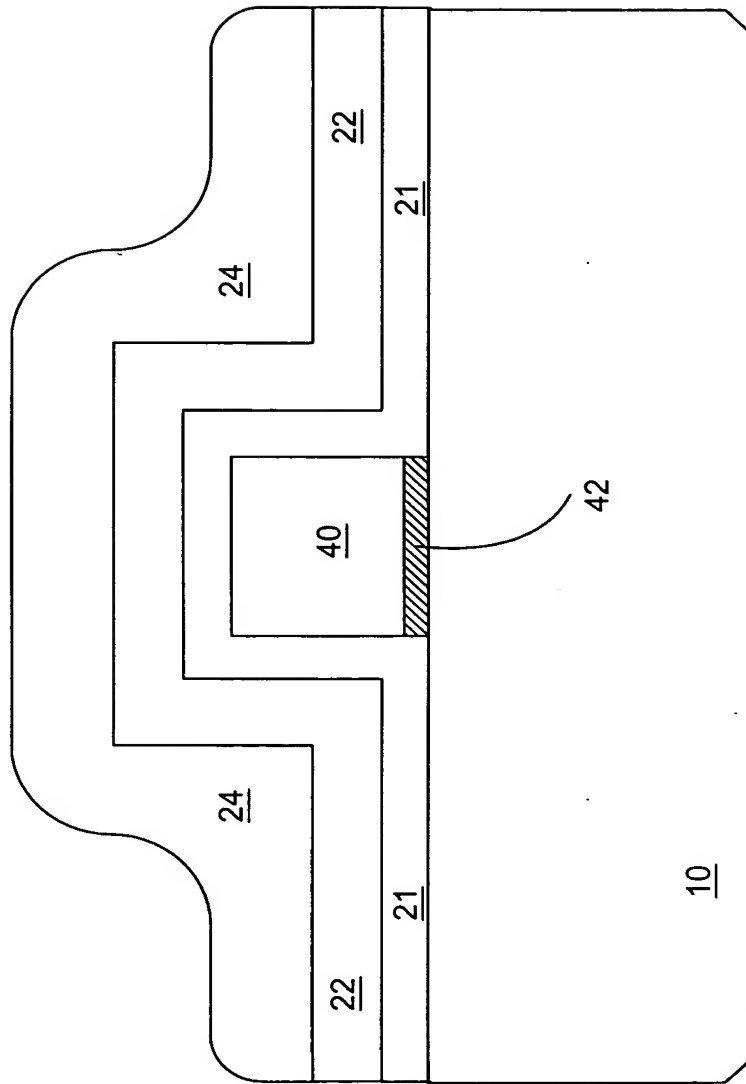


FIG. 4

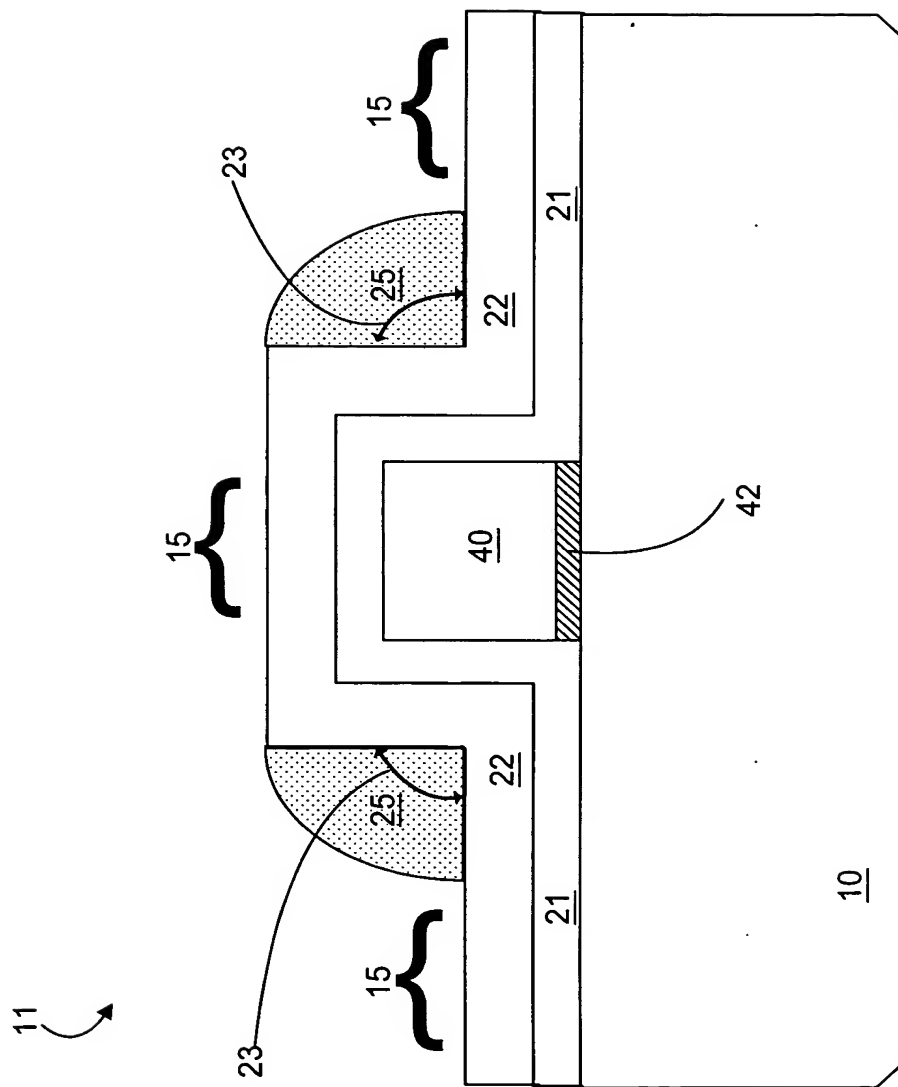


FIG. 5

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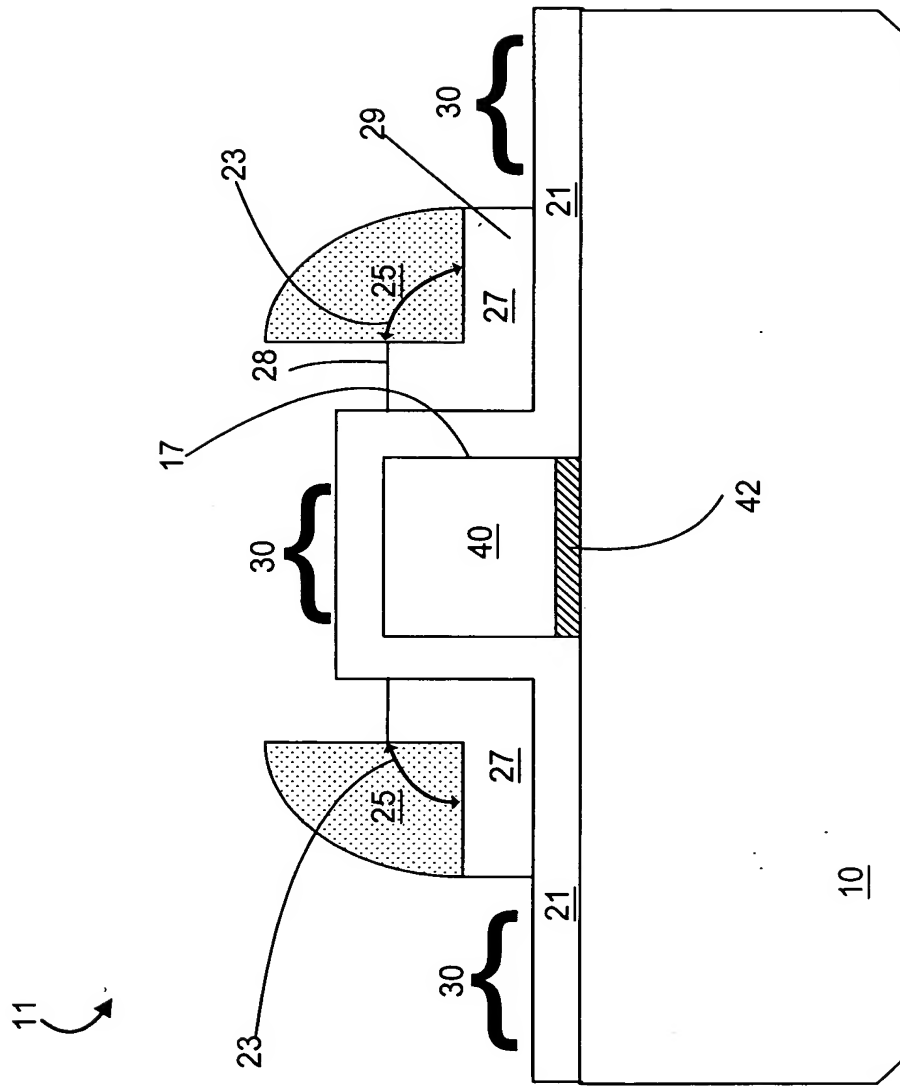


FIG. 6

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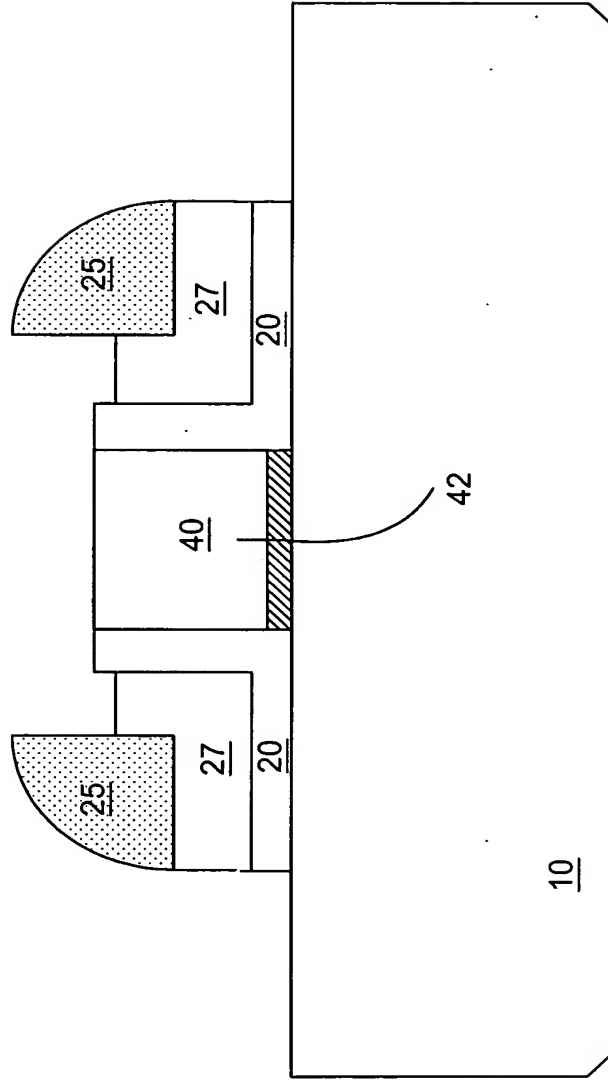


FIG. 7

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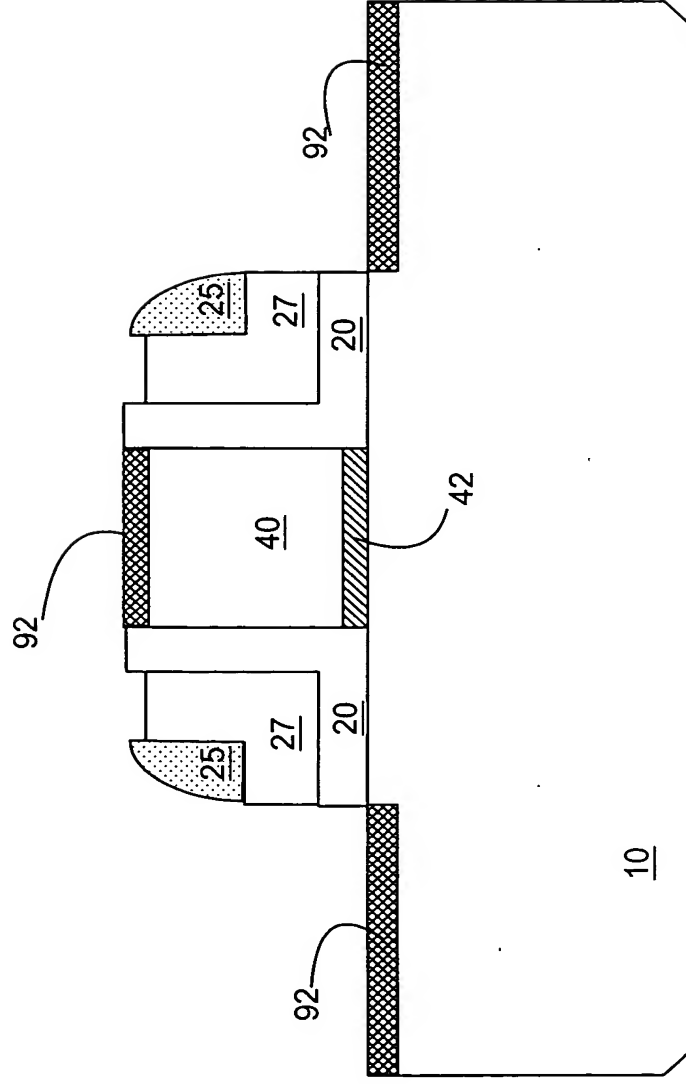


FIG. 8



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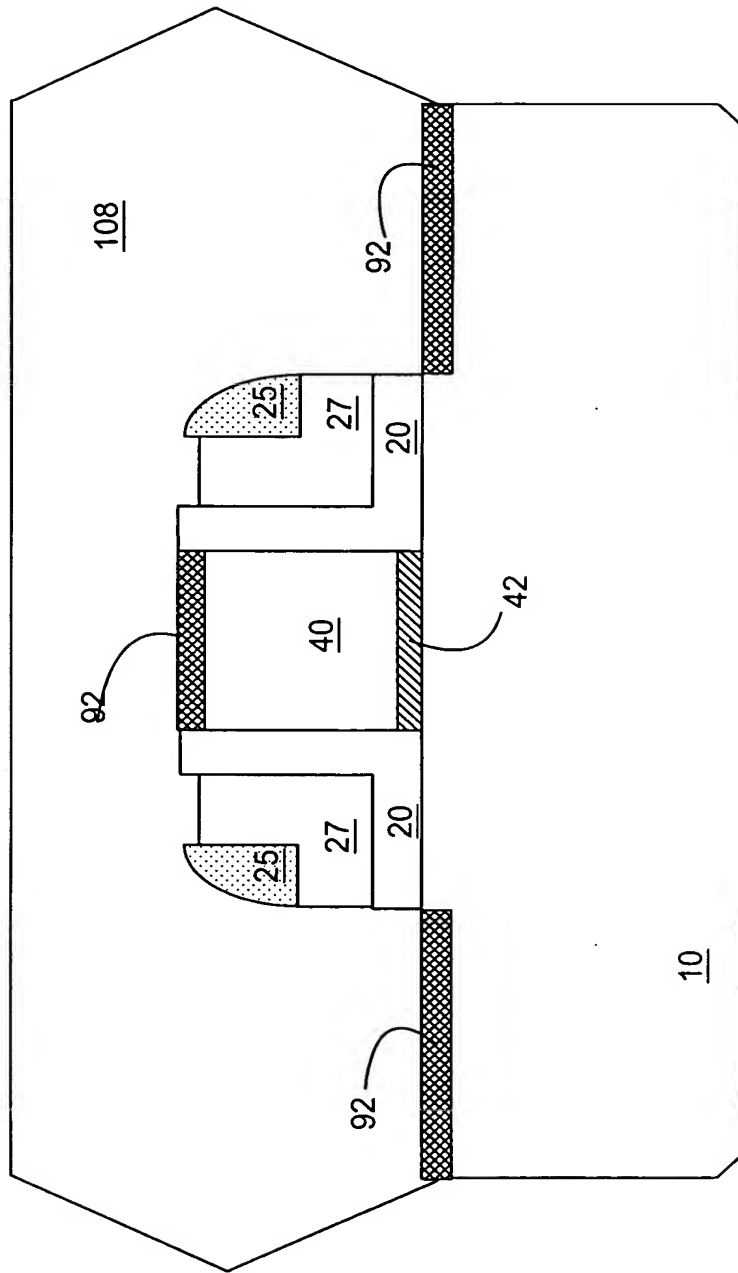


FIG. 9

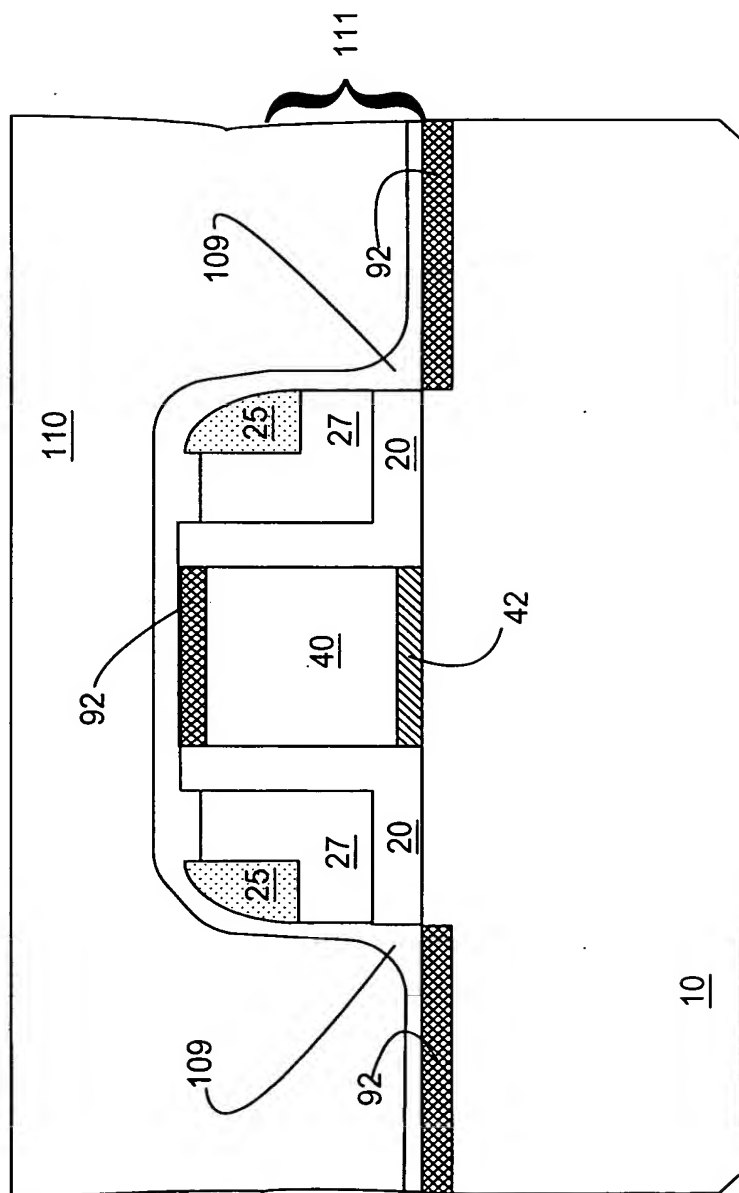


FIG. 10

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11

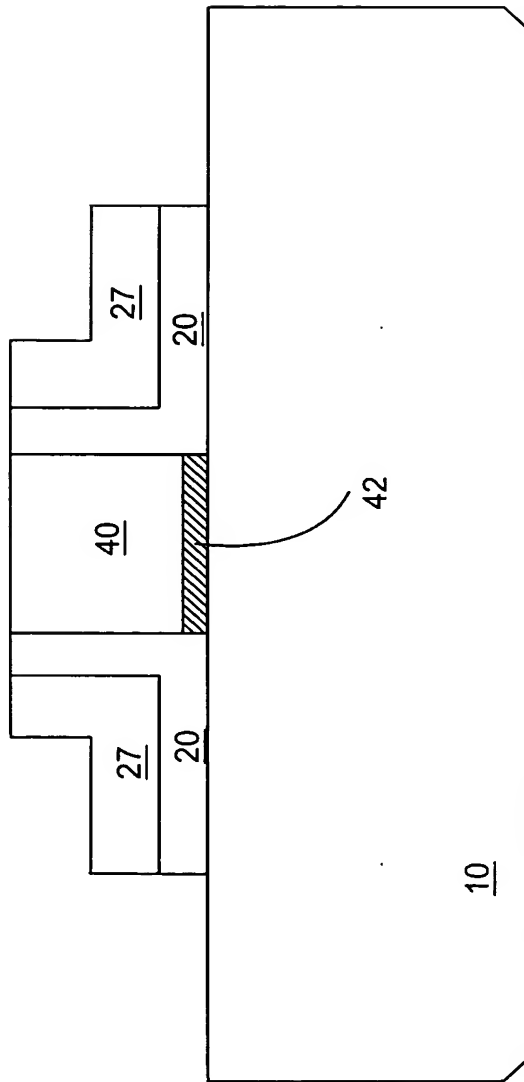


FIG. 11

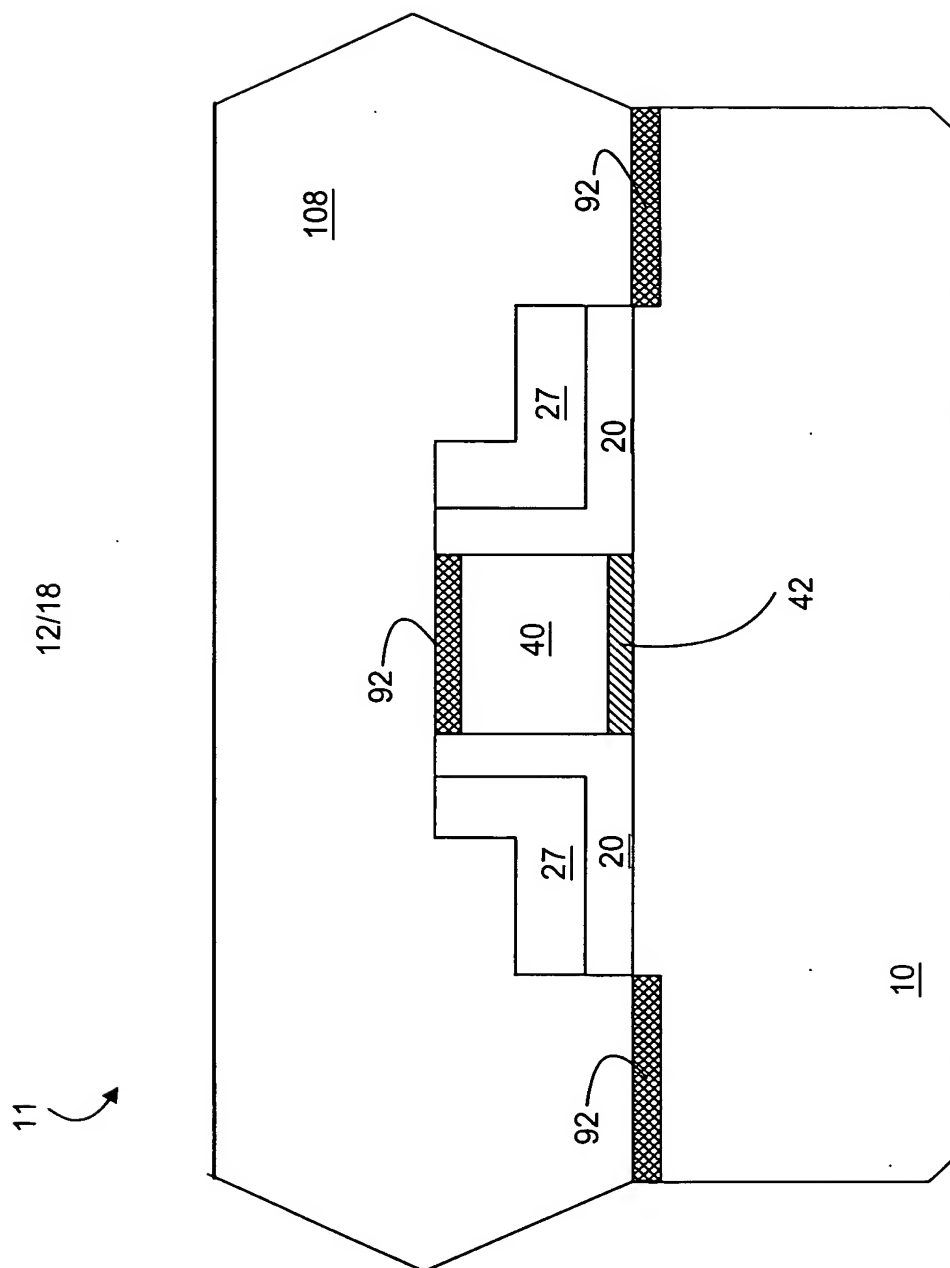


FIG. 12

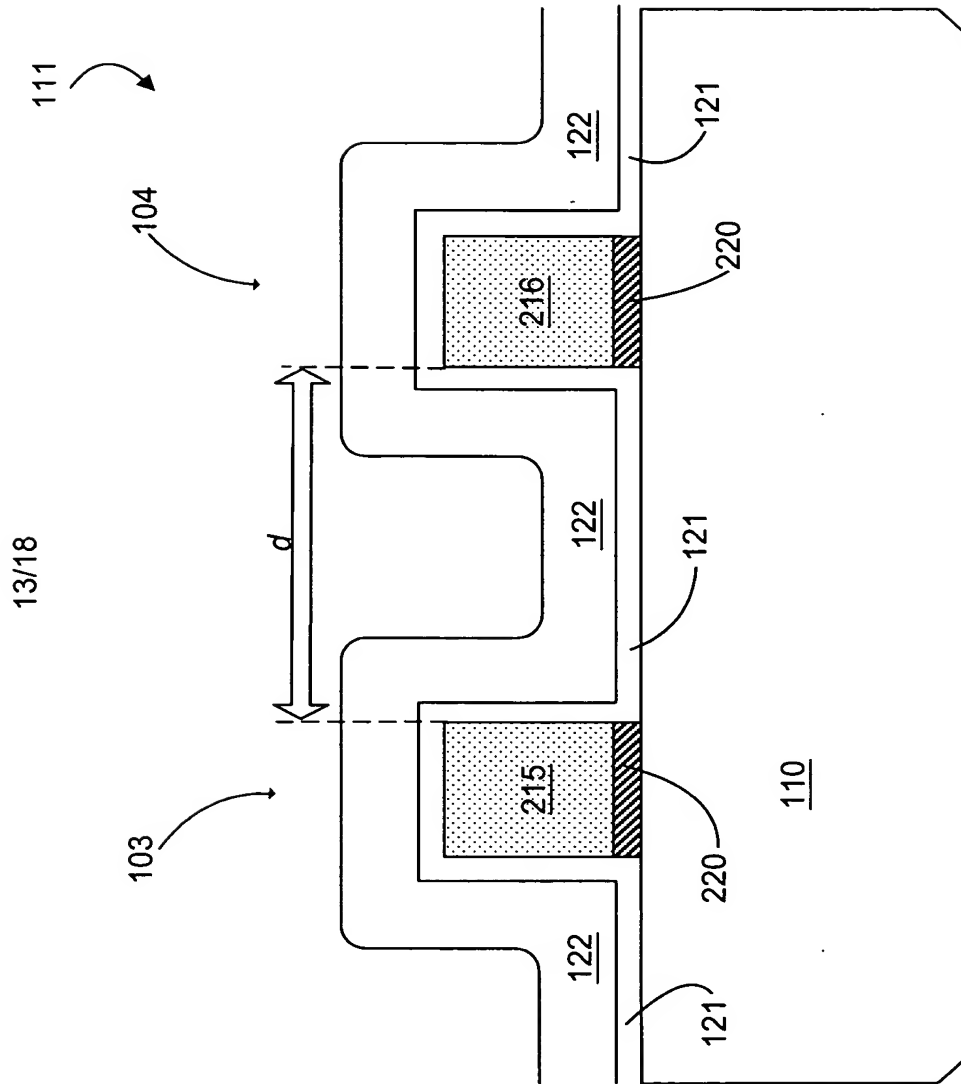


FIG. 13

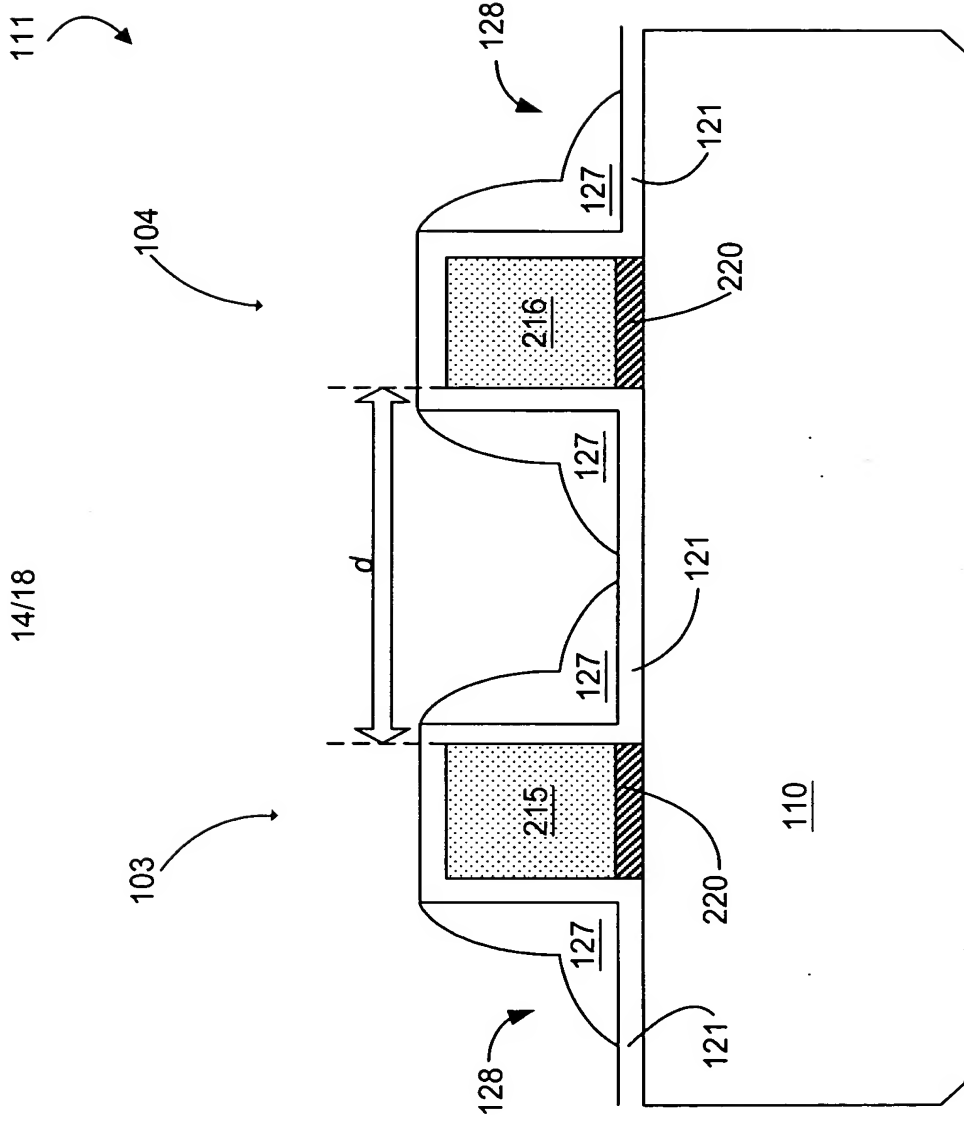


FIG. 14

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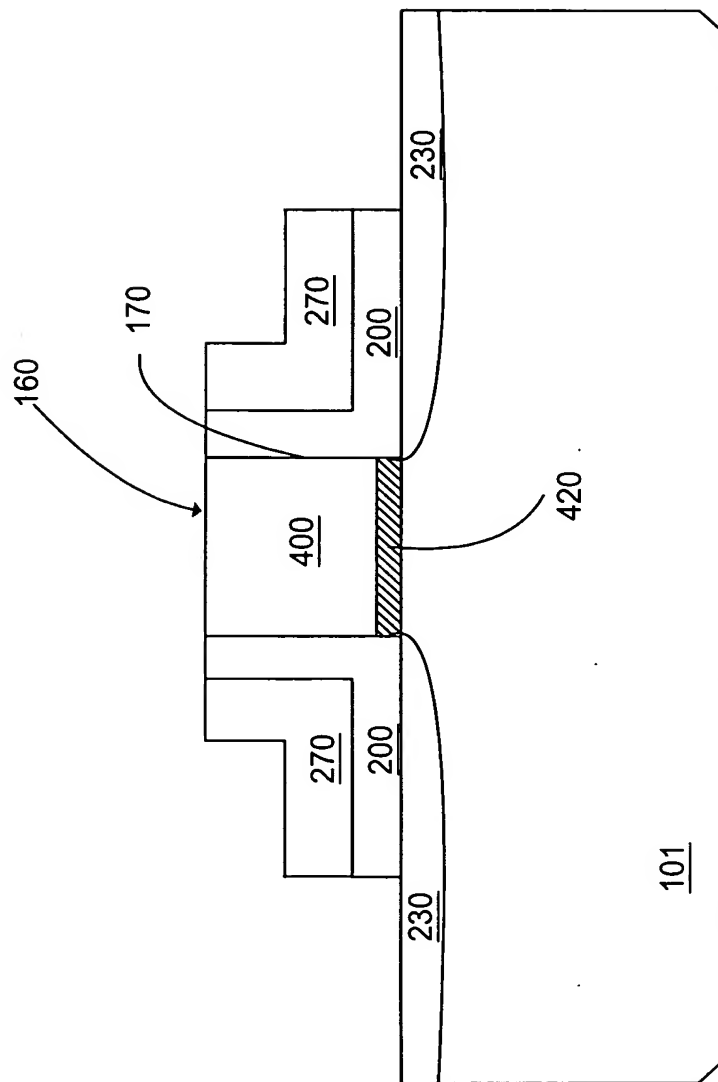


FIG. 15